

## **SMT Inductor**

Product Class: Date		Shielded Power Inductor B82472P6***M000 21.10.2011		8	100 7173	5		
					/1/3			
IMDS ID								
if available								
Version:		06						
Product Part (IMDS: semi component)	Materia (IMDS:	<b>I Class</b> Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)
Active Part	Ceramic		4B	Nickel Zinc Ferrite	100	12645-50-0	63.0	
	Heavy Metal		1C	Cu	100	7440-50-8	25.2	
	Elastomer		2B	Polyurethane (PUR)	100	68400-67-9	1.3	
Encapsulation and Mounting	Thermoplastic		2A	Liquid Crystal Polymer (LCP)	70	147310-94-9	6.0	
			28	Glass fiber 30 65997-17-3		0.0		
	Duromer		2C	Epoxy (EP)	100	25068-38-6	1.2	
	Elastomer		2B	Polydimethylsiloxane (PDMS)	100	63148-62-9	1.8	
	Duromer		2C	Polyimide (PI)	100		0.5	
Termination	Heavy Metal		1C	Cu	94	7440-50-8	0.9	
			1C	Sn	6	7440-31-5		
	Heavy Metal		1C	Ni	100	7440-02-0		х
	Heavy Metal		1C	Sn	100	7440-31-5	0.1	
						Sum in total:	100.0	

[max. in mm]	lapp
7.5 x 7.5 x 4.5	

approx. in g] 1.5

## Not part of a Product Class

Contact	Dr. Johann Reindl, MAG	EPQM	Imp	Important remarks:			
Division	TDK Electronics AG, Ma	gnetics Business Group (MAG)	1)	The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906) Traces are			
Address	Rosenheimer Strasse 116b, 81669 Munich			product parts, substances etc. that are below a percentage of 0.1 % by weight, if no otherwise regulated.			
	Tel: +49 89 54020 3030	mailto:	2)	This Material Data Sheet contains typical values of the respective products set forth			
		johann.reindl@tdk-electronics.tdk.com		herein. We expressly point out that all values and statements contained herein are			
*) others: .(not declarable or prohibited substances acc. GADSL)				based on our best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK			
**) typical mass percentage of substance				ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR			
ĺ				STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED			
				HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR			
				WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.			

The products set forth herein are "RoHS-compatible". RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8<sup>th</sup>, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

RoHS - Exemptions for the Product Class / Product according to Annex III: ( 🗵 valid 🗅 not valid )

B82472P6\*\*\*M000

☑ no exemptions;

Exemption 6 (a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight;

Exemption 6 (b): Lead as an alloying element in aluminium containing up to 0,4 % lead by weight;

Exemption 6 (c): Copper alloy containing up to 4 % lead by weight;

Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead);

Exemption 7 (c)-I: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound;

Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher;

Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;

Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;

□ Other Exemption than above .....